

12V P-Channel Enhancement Mode MOSFET

Description

The PECN1205MR uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 1.8V. This device is suitable for use as a load switch or in PWM applications.

General Features

- ◆ $V_{DS} = -12V$, $I_D = -5A$
 $R_{DS(ON)}(Typ.) = 34m\Omega$ @ $V_{GS} = -2.5V$
 $R_{DS(ON)}(Typ.) = 28m\Omega$ @ $V_{GS} = -4.5V$
- ◆ High power and current handling capability
- ◆ Lead free product is acquired
- ◆ Surface mount package

Application

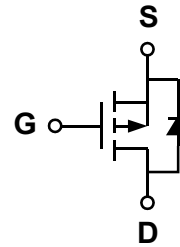
- ◆ PWM applications
- ◆ Load switch

Package

- ◆ SOT-23-3L

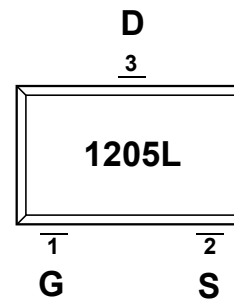


Schematic diagram



Marking and pin assignment

SOT-23-3L
(TOP VIEW)



1205----PECN1205

L----- Package Information

Ordering Information

Part Number	Storage Temperature	Package	Devices Per Reel
PECN1205M R-G	-55°C to +150°C	SOT-23-3L	3000

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

parameter	symbol	limit	unit	
Drain-source voltage	V_{DS}	-12	V	
Gate-source voltage	V_{GS}	± 12	V	
Continuous Drain Current	I_D	$T_A = 25^\circ C$	-5	A
		$T_A = 70^\circ C$	-4	A
Pulsed Drain Current ^C	I_{DM}	-20	A	
Maximum power dissipation ^B	P_D	$T_A = 25^\circ C$	1.4	W
		$T_A = 70^\circ C$	0.9	W
Operating junction Temperature range	T_j	-55—150	°C	

Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
OFF Characteristics						
Drain-source breakdown voltage	BV_{DSS}	$V_{GS}=0V, I_D=-250\mu A$	-12	-16.5	-	V
Zero gate voltage drain current	I_{DSS}	$V_{DS}=-12V, V_{GS}=0V$	-	-	-1	μA
Gate-body leakage	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 12V$	-	-	± 100	nA
ON Characteristics						
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-0.4	-0.7	-1.2	V
Drain-source on-state resistance	$R_{DS(ON)}$	$V_{GS}=-4.5V, I_D=-5A$	-	28	45	m Ω
		$V_{GS}=-2.5V, I_D=-4A$	-	34	60	
Forward transconductance	g_{fs}	$V_{GS}=-5V, I_D=-5A$	-	5	-	S
Dynamic Characteristics						
Input capacitance	C_{ISS}	$V_{DS}=-6V, V_{GS}=0V$ $f=1.0MHz$	-	740	-	pF
Output capacitance	C_{OSS}		-	290	-	
Reverse transfer capacitance	C_{RSS}		-	190	-	
Switching Characteristics						
Turn-on delay time	$t_{D(ON)}$	$V_{DD}=-6V$ $I_D=-5A$ $V_{GEN}=-4.5V$ $R_L=1.0\Omega$ $R_{GEN}=1\Omega$	-	12.5	-	ns
Rise time	t_r		-	35	-	
Turn-off delay time	$t_{D(OFF)}$		-	30	-	
Fall time	t_f		-	10	-	
Total gate charge	Q_g	$V_{DS}=-6V, I_D=-5A$ $V_{GS}=-4.5V$	-	7.8	-	nC
Gate-source charge	Q_{gs}		-	1.2	-	
Gate-drain charge	Q_{gd}		-	1.6	-	
DRAIN-SOURCE DIODE CHARACTERISTICS						
Diode forward voltage	V_{SD}	$V_{GS}=0V, I_S=-1.25A$	-	-0.81	-1.2	V

Thermal Characteristics

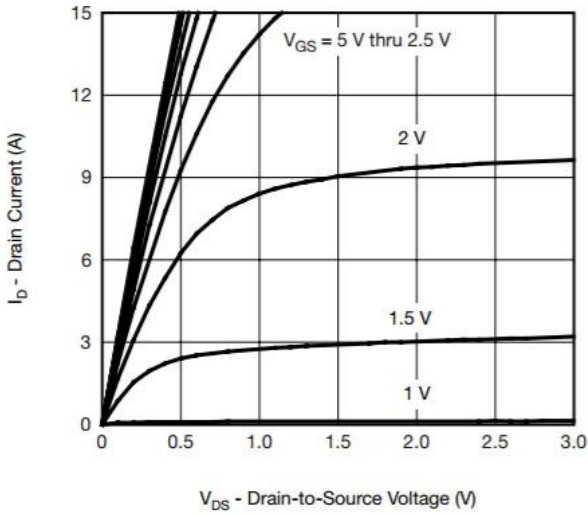
Parameter	Symbol	Typ.	Max.	Unit
Maximum Junction-to-Ambient ^A	$t \leq 10s$	70	90	°C/W
Maximum Junction-to-Ambient ^{A D}	Steady-State			
Maximum Junction-to-Lead	Steady-State	62	80	

A. The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ C$. The value in any given application depends on the user's specific board design.

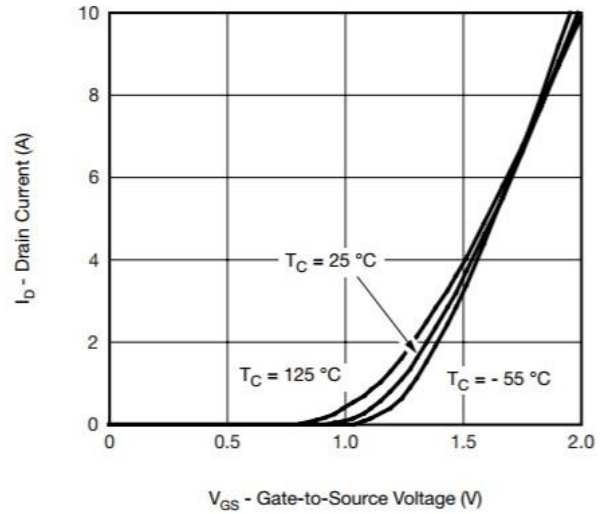
B. The power dissipation PD is based on $T_{J(MAX)}=150^\circ C$, using $\leq 10s$ junction-to-ambient thermal resistance.

C. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}=150^\circ C$. Ratings are based on low frequency and duty

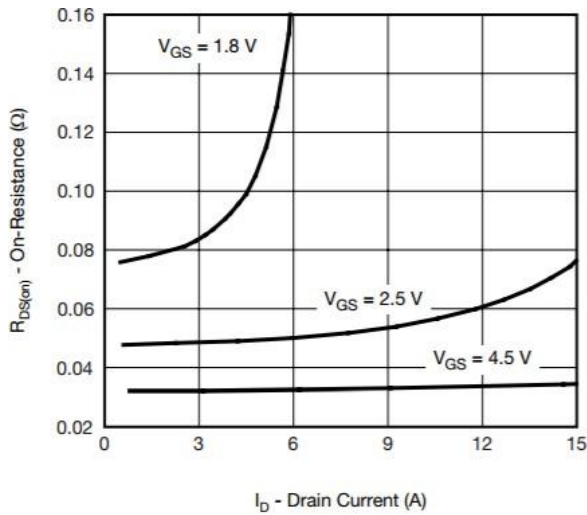
Typical Performance Characteristics



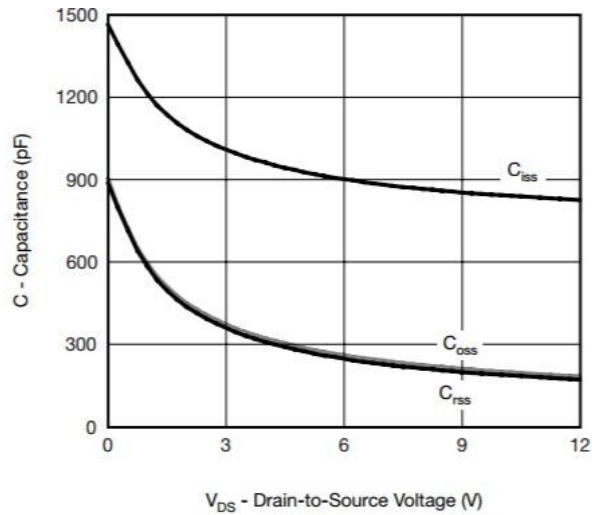
Output Characteristics



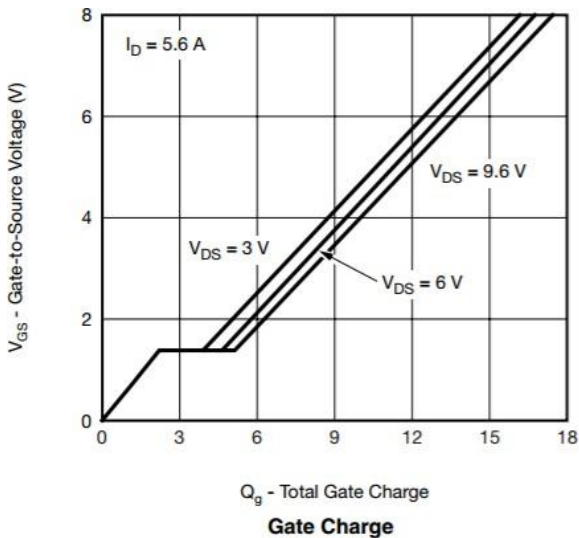
Transfer Characteristics



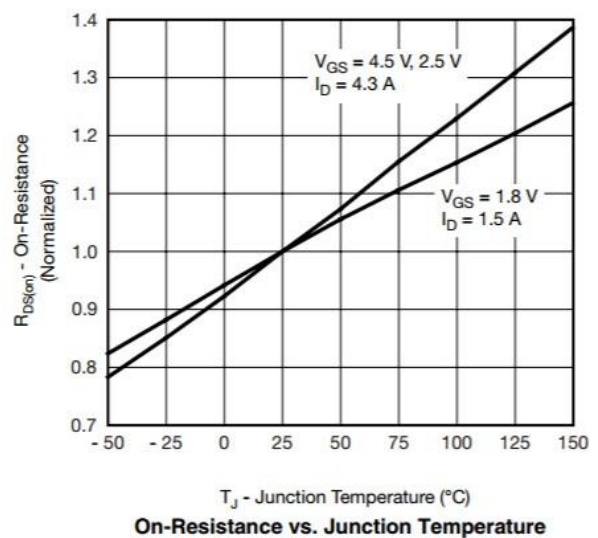
On-Resistance vs. Drain Current and Gate Voltage



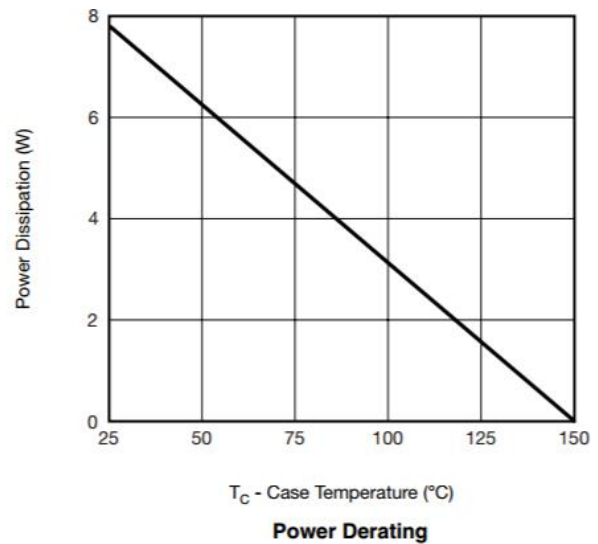
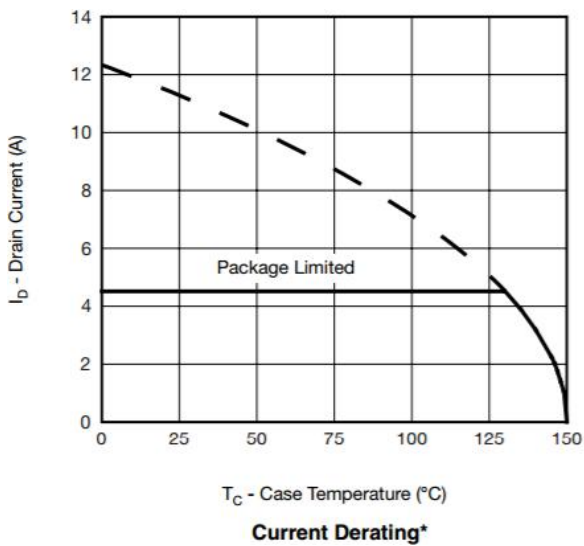
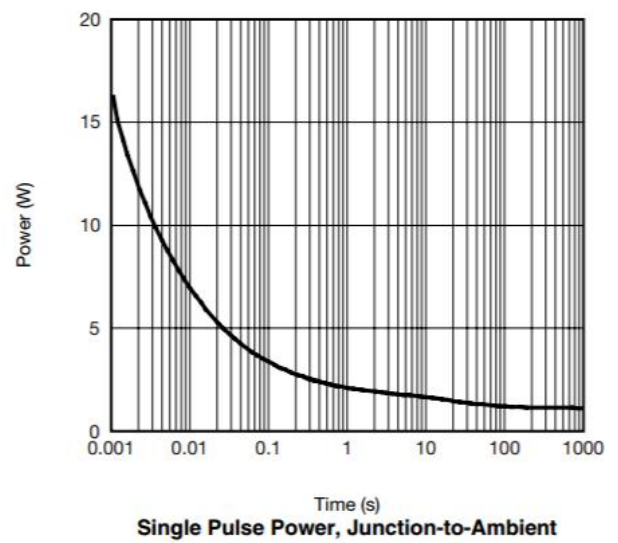
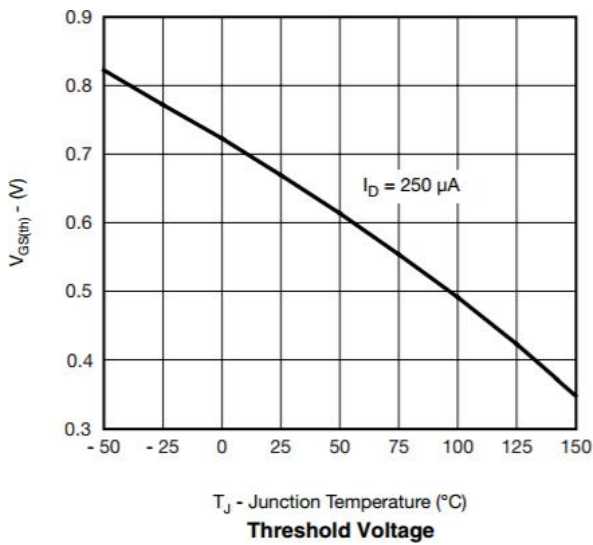
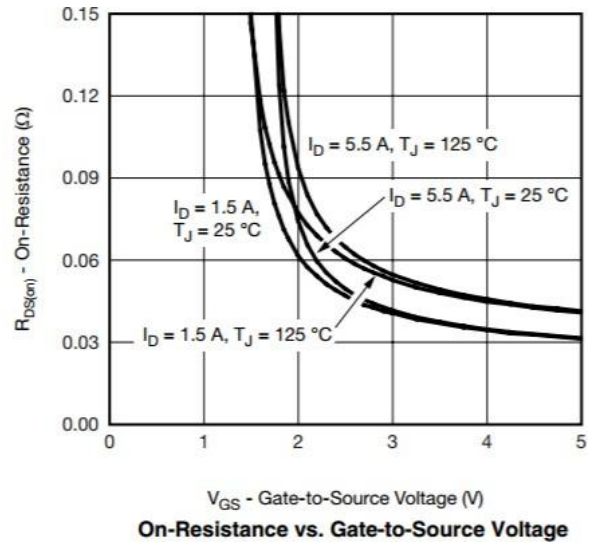
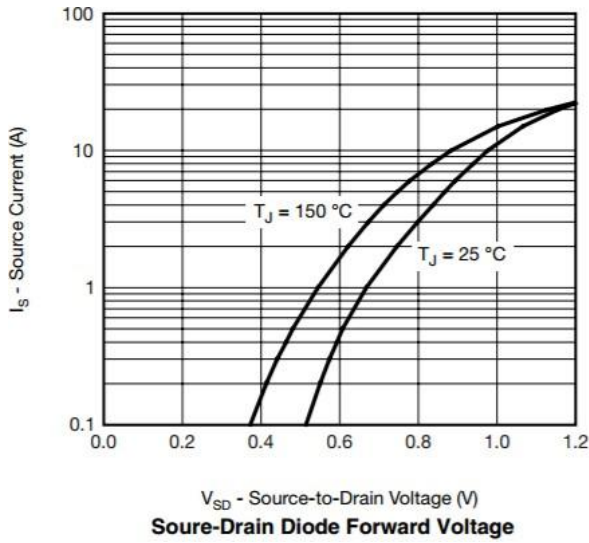
Capacitance

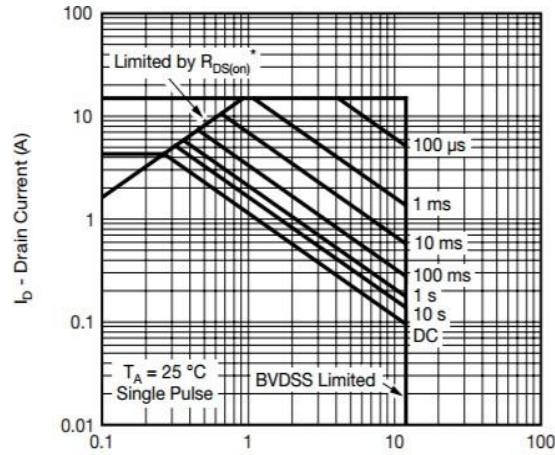


Gate Charge

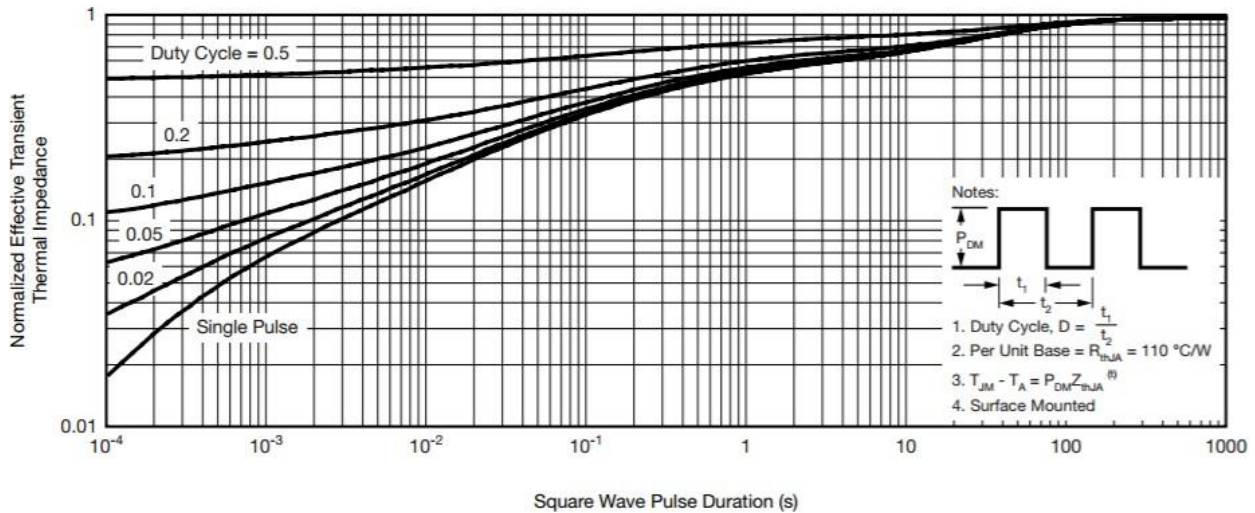


On-Resistance vs. Junction Temperature

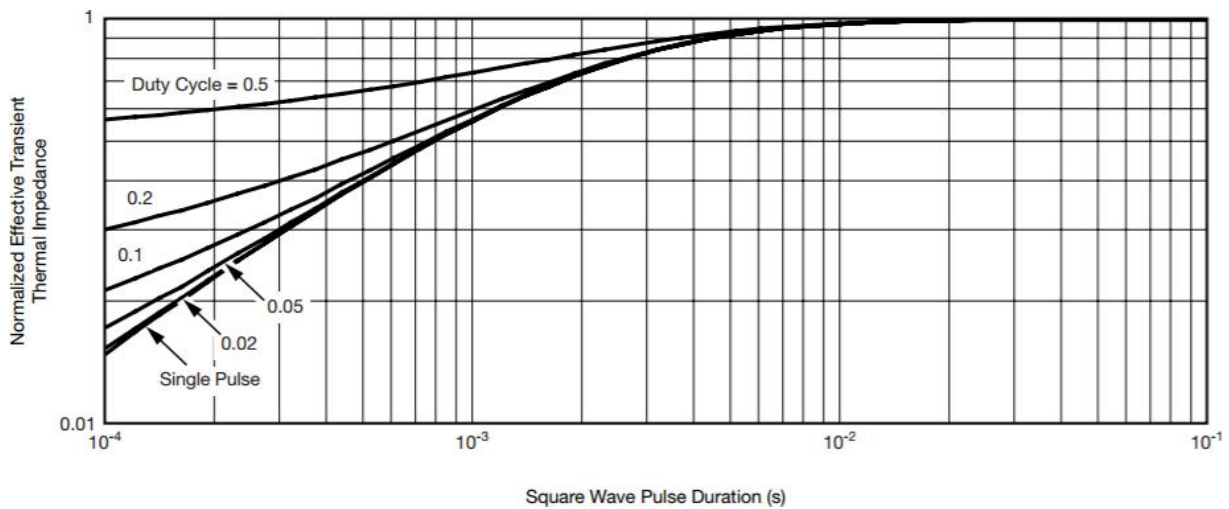




V_{DS} - Drain-to-Source Voltage (V)
 $V_{GS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified
Safe Operating Area, Junction-to-Ambient



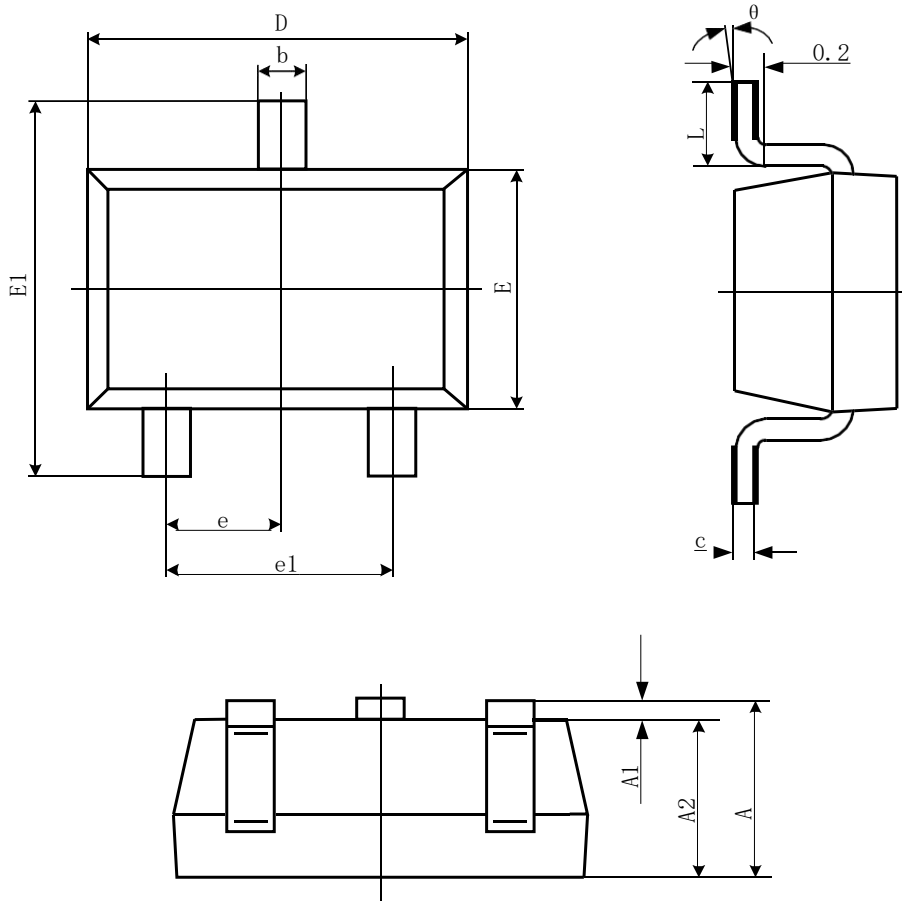
Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Package Information

- SOT-23-3L



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°